

Vishay Semiconductors

Small Surface Mount Ultrafast Diodes

Features

- · For surface mounted applications
- Low profile package
- · Ideal for automated placement
- · Glass passivated
- High temperature soldering: 260 °C/10 s at terminals
- · Wave and reflow solderable
- · AEC-Q101 qualified
- Compliant to RoHS directive 2002/95/EC and in accordance to WEEE 2002/96/EC



Mechanical Data

Case: DO-219AB (SMF)

Polarity: band denotes cathode end

Weight: approx. 15 mg
Packaging codes/options:

GS18/10K per 13" reel (8 mm tape) GS08/3K per 7" reel (8 mm tape)

Parts Table

Part	Ordering code	Marking	Remarks
ES07B	ES07B-GS18 or ES07B-GS08	EB	Tape and reel
ES07D	ES07D-GS18 or ES07D-GS08	ED	Tape and reel

RoHS

Absolute Maximum Ratings

T_{amb} = 25 °C, unless otherwise specified

Parameter	Test condition	Part	Symbol	Value	Unit
Maximum rapatitiva poak rayaraa valtaga		ES07B	V _{RRM}	100	V
Maximum repetitive peak reverse voltage		ES07D	V _{RRM}	200	V
Maximum DMC valtage		ES07B	V _{RMS}	70	V
Maximum RMS voltage		ES07D	V _{RMS}	140	V
Manian un DC blanking valtage		ES07B	V _{DC}	100	V
Maximum DC blocking voltage		ES07D	V _{DC}	200	V
Maximum average forward rectified current	T _{tp} = 105 °C		I _{F(AV)}	1.2	Α
	T _A = 65 °C ¹⁾		I _{F(AV)}	0.5	Α
Peak forward surge current 8.3 ms single half sine-wave	T _L = 25 °C		I _{FSM}	30	А

Note:

1) Mounted on epoxy glass PCB with 3 mm x 3 mm, Cu pads (≥ 40 µm thick)

Rev. 1.9, 20-Aug-10

Vishay Semiconductors

Thermal Characteristics

T_{amb} = 25 °C, unless otherwise specified

Parameter	Test condition	Symbol	Value	Unit
Thermal resistance junction to ambient air 1)		R _{thJA}	180	K/W
Operating junction and storage temperature range		T _j , T _{stg}	- 55 to + 150	°C

Electrical Characteristics

T_{amb} = 25 °C, unless otherwise specified

Parameter	Test condition	Symbol	Min.	Тур.	Max.	Unit
Maximum instantaneous forward voltage	1 A ¹⁾	V _F			0.98	٧
Maximum DC reverse current at rated DC blocking voltage	T _A = 25 °C	I _R			10	μΑ
	T _A = 100 °C	I _R			50	μΑ
Reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1 \text{ A}, I_{rr} = 0.25 \text{ A}$	t _{rr}			25	ns
Typical capacitance	4 V, 1 MHz	C _j		4		pF

Typical Characteristics T_{amb} = 25 °C, unless otherwise specified

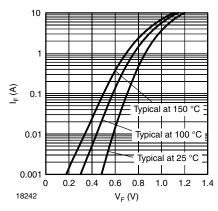


Figure 1. Typical Forward Characteristics

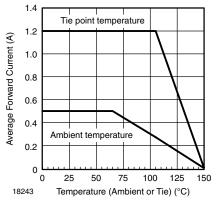


Figure 2. Forward Current Derating Curve

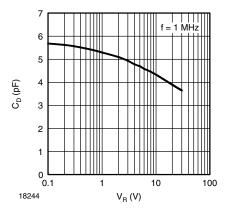


Figure 3. Typ. Diode Capacitance vs. Reverse Voltage

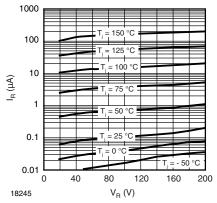


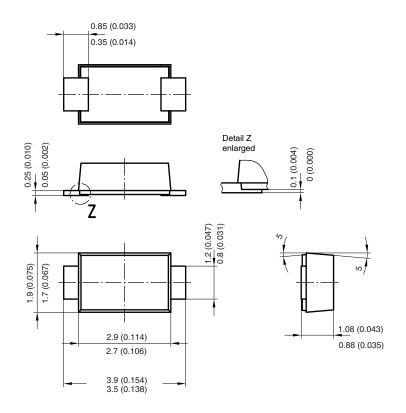
Figure 4. Typical Reverse Characteristics

¹⁾ Mounted on epoxy glass PCB with 3 x 3 mm, Cu pads (≥ 40 µm thick)

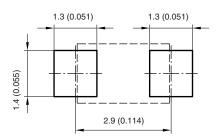
 $^{^{1)}}$ Pulse test, 300 μs pulse with 1 % duty cycle



Package Dimensions in millimeters (inches): DO-219AB (SMF)



Foot print recommendation:

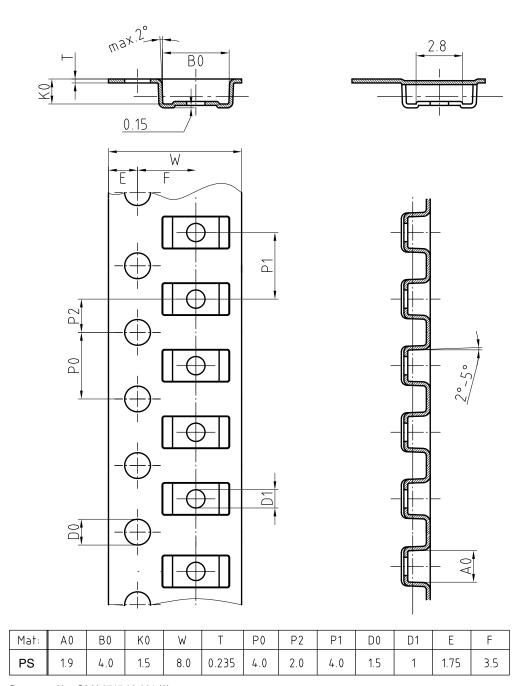


Created - Date: 15. February 2005 Rev. 3 - Date: 13. March 2007 Document no.:S8-V-3915.01-001 (4)

Vishay Semiconductors



Blistertape Dimensions for SMF in millimeters



Document-No.: S8-V-3717.02-001 (3)

18513

Legal Disclaimer Notice



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk and agree to fully indemnify and hold Vishay and its distributors harmless from and against any and all claims, liabilities, expenses and damages arising or resulting in connection with such use or sale, including attorneys fees, even if such claim alleges that Vishay or its distributor was negligent regarding the design or manufacture of the part. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Document Number: 91000 www.vishay.com
Revision: 11-Mar-11 1